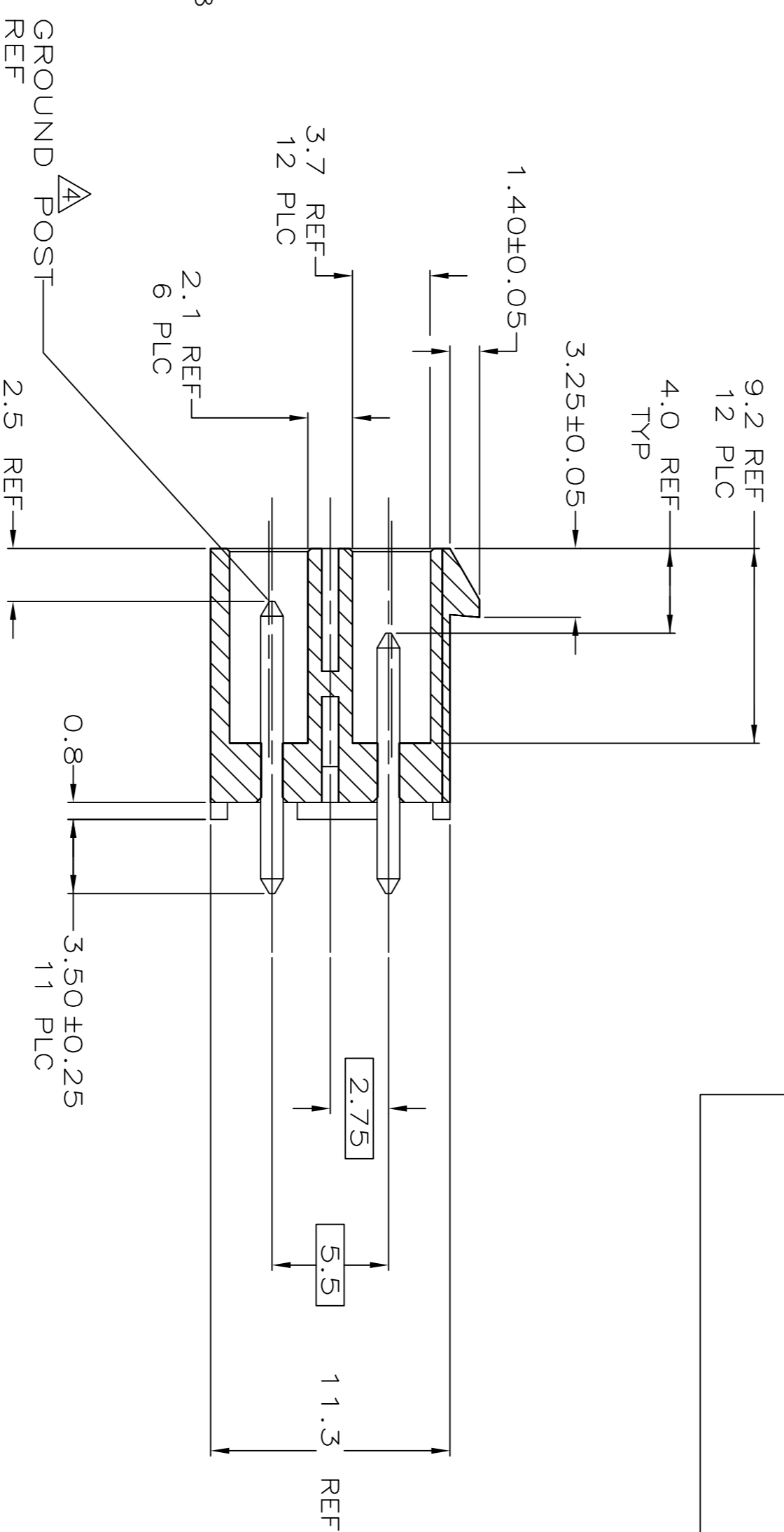
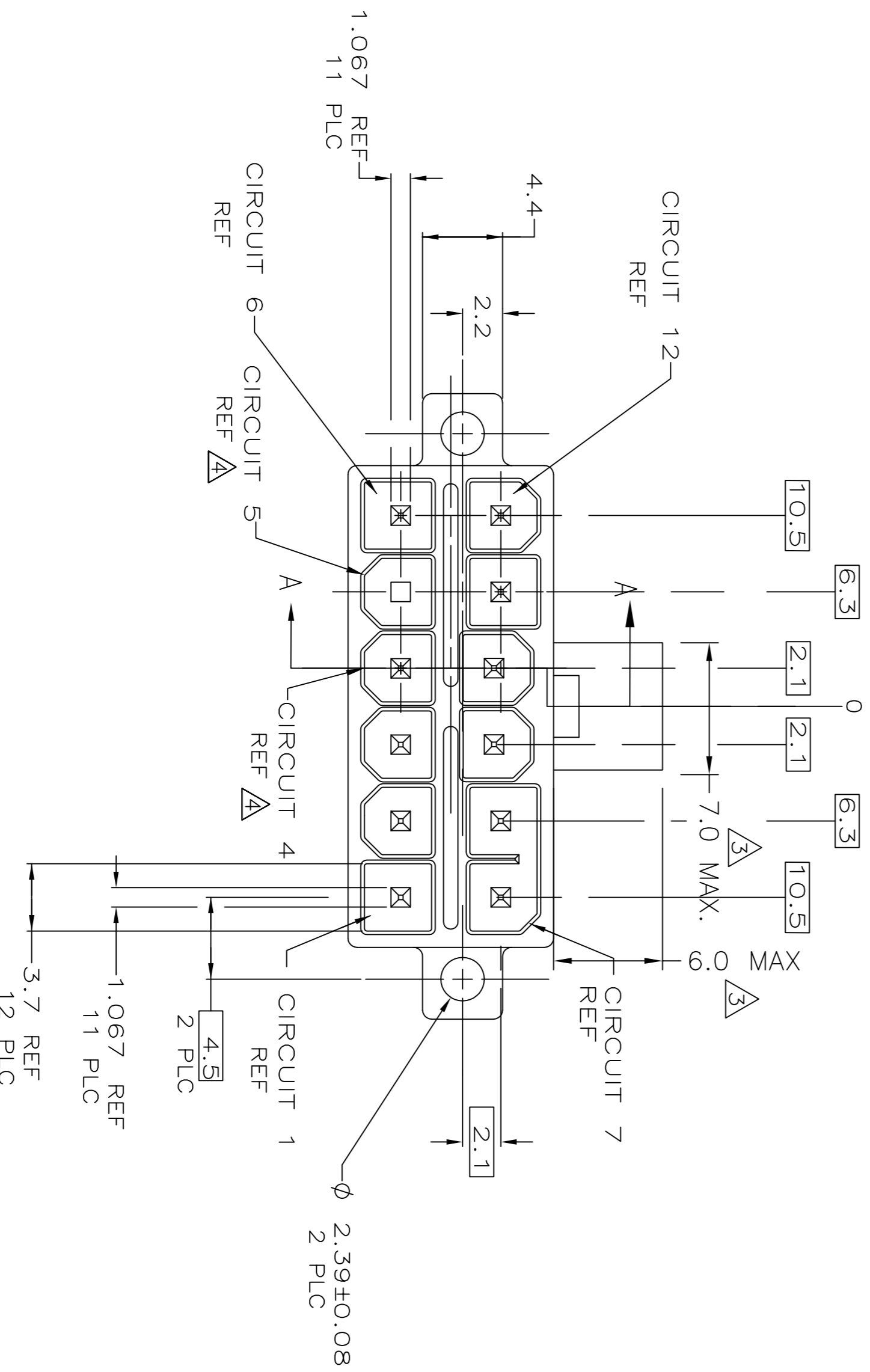


RECOMMENDED MOUNTING HOLE PATTERN FOR 1.78 MAX THICK P.C. BOARD COMPONENT SIDE SHOWN

- △ CONTACT: 0.00076 GOLD AT INTERFACE. 0.00254 MIN MATTE TIN ON SOLDER TAIL. 0.00127 MIN NICKEL UNDERPLATE ALL OVER.
- 2. MATES WITH AMP-DUAC/PL PLUG RECEPTACLE 794156-1 AND ITS CONTACTS.
- △ CLEARANCE ENVELOPE FOR MATING PLUG RECEPTACLE LATCH.
- △ CONTACT GROUND POST LOCATED IN CIRCUIT 4, NO CONTACT IN CIRCUIT 5. OTHER POSTS STANDARD.
- △ HOLE SUPPORTING CIRCUIT 5 NOT REQUIRED WHEN USING P/N 2232521-1

REV	DESCRIPTION	DATE	BY
5	INITIAL RELEASE	10/21/2013	OL SZ

PRELIMINARY



SECTION A-A

MATERIAL	FINISH	MATERIAL	COLOR	PART NO
HIGH CONDUCTIVITY COPPER ALLOY	△1	PBT, UL94V-0	NATURAL(WHITE)	2232521-1

THIS DRAWING IS A CONTROLLED DOCUMENT. ESTE PLANO ES UN DOCUMENTO CONTROLADO.	DATE / FECHA	REV / REV	DESCRIPTION / DESCRIPCION
DATE / FECHA: 5/29/2013	REV / REV: 5/29/2013	DESCRIPTION / DESCRIPCION: REVISED	
APPROVED BY / APROBADO POR: SUNYI ZHAO	DATE / FECHA: 5/29/2013	DESCRIPTION / DESCRIPCION: AMP-DUAC/PL	
DATE / FECHA: 5/29/2013	REV / REV: 5/29/2013	DESCRIPTION / DESCRIPCION: AMP-DUAC/PL	
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DATE / FECHA: 5/29/2013	REV / REV: 5/29/2013	DESCRIPTION / DESCRIPCION: AMP-DUAC/PL	

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)